

面京鼎精密科技

Foxsemicon
2020 First Quarter
Investor Presentation

2020/6/23

Operation Profile

Stanley Lu Spokesman

- Company Profile
- Development strategy
- Operation Performance
- Q&A

Kevin Chiu CEO

Frank Chen CFO

Stanley Lu Spokesman

- We have made forward-looking statements in the presentation. Our forward-looking statements contain information regarding our financial conditions and business strategies. We have based these forward-looking statements on our current expectations and projection are reasonable, such forward-looking statements are inherently subject to risk, uncertainties, and assumptions about us.
- We undertake no obligation to publicly update or revise any forward-looking statements whether as a result of new information, future events or otherwise. In light of these risk, uncertainties and assumptions, the forward-looking events in the conference might not occur and our actual results could differ materially from those anticipated in these forward-looking statements.







Foxsemicon Integrated Technology, Inc.(Fiti)

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Established: 2001/04/26

Capital: NT\$ 827 million

Chairman: Young Liu

CEO: Kevin Chiu

Business:

- Semiconductor equipment (Contract Manufacturing)
- Non-semiconductor process and automation equipment(Total Solution Provider)

Awards and Milestone:

- 2001 Company set-up
- 2002 Approved vendor certified by the largest semiconductor equipment maker of the world
- 2015 IPO on Taiwan Stock Exchange
- 2016 Supplier Aftermarket Collaboration _ awarded by world's leading semiconductor equipment provider
- 2017 Contract Manufacturing supplier of the year J
 and 「Global Services Accelerated Growth and
 Performance 」 awarded by world's leading
 semiconductor equipment provider
- Contract Manufacturing supplier of the year awarded by world's leading semiconductor equipment provider
- F Best in Class Performance. 」 awarded by world's leading semiconductor equipment provider (For three consecutive years to obtain)

Headquarter(Taiwan)



Chunan Plant 1

USA



San Jose & Austin

Shanghai



Songjiang Plant



Jiangsu



Kunshan Plant

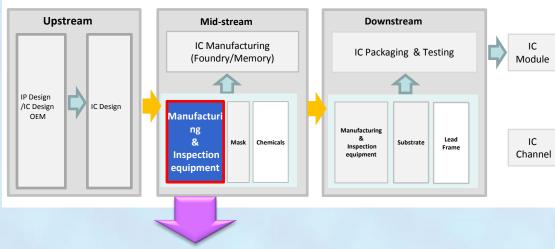
Taiwan-Chunan



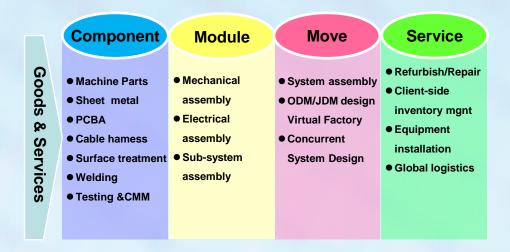
Chunan Plant 2-2021

- Fiti's current stronghold
- Fiti's Future Expansion Position

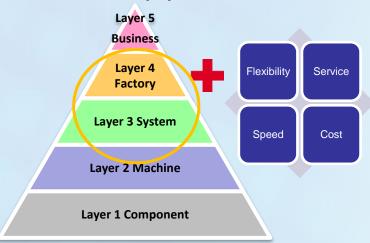
Semiconductor front-end process equipment



Contract Manufacture Business Model



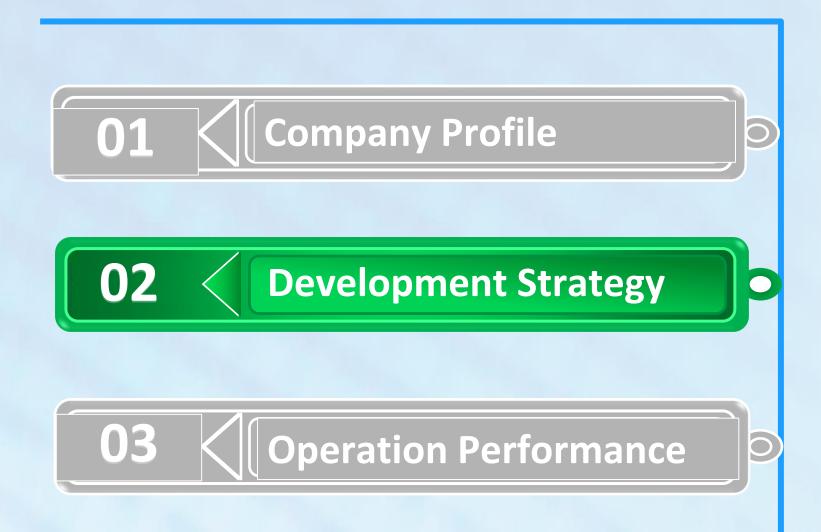
Non-semiconductor process and automation equipment











Semiconductor equipment manufacturing

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Manufacturing Service Center

- Production of semiconductor equipment consumables and spare parts
- Repair and maintenance of equipment systems and modules
- Logistics management of parts supplies

Technical Service Center

- Assembling and adjusting precision semiconductor equipment
- Production of precision high cleanliness semiconductor equipment components
- Semiconductor equipment grade precision surface treatment

Equipment R & D Center

- Fab automation equipment design and development capabilities
- Joint equipment development with international companies



Key spare parts and consumable services

Fab micro pollution prevention solution



Equipment repair and renovation services



Module integrated



Key components





Industry Development Strategy

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- Semiconductor wafer process equipment manufacturing(etching, thin film, CMP)
- Solar/Panel/LED Equipment Manufacturing
- Critical process spare parts

- Equipment recycling service
- Parts recycling service
- Technology-derived application services

Semiconductor equipment life cycle manufacturing &services

Equipment and key

components

Circular economy

Fab automation development and manufacturing

- Non-process equipment development
- Micro Contamination Control solution
- Wafer AOI inspection equipment
- Nitrogen storage system
- ➤ Wafer transfer automation

Medical equipment development and manufacturing

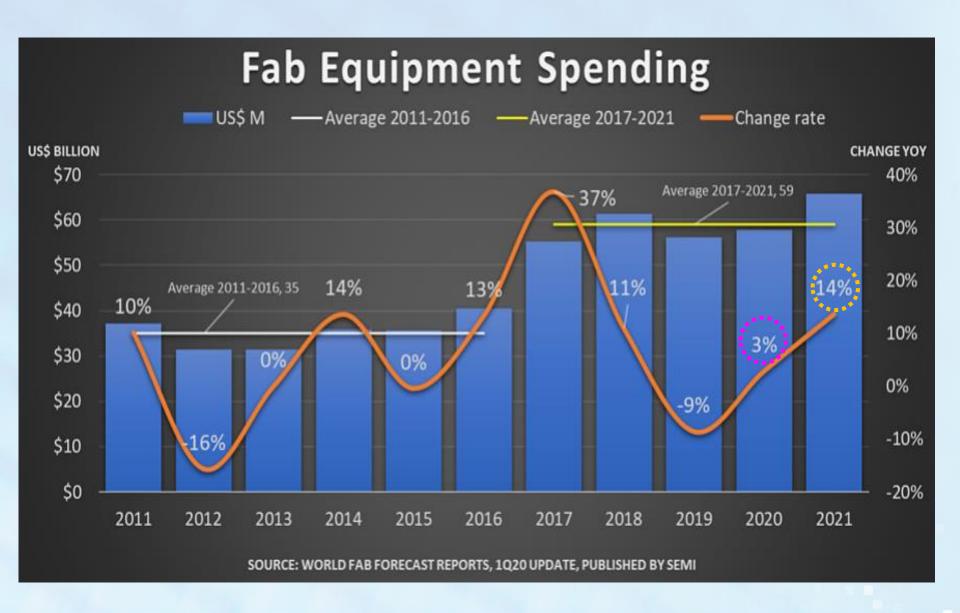
- Medical image diagnostic equipment
- Key components of medical equipment
- Smart medical peripheral facilities
- Radiotherapy equipment

High cleanliness, high vacuum, zero pollution,
The process must comply with Copy Exact

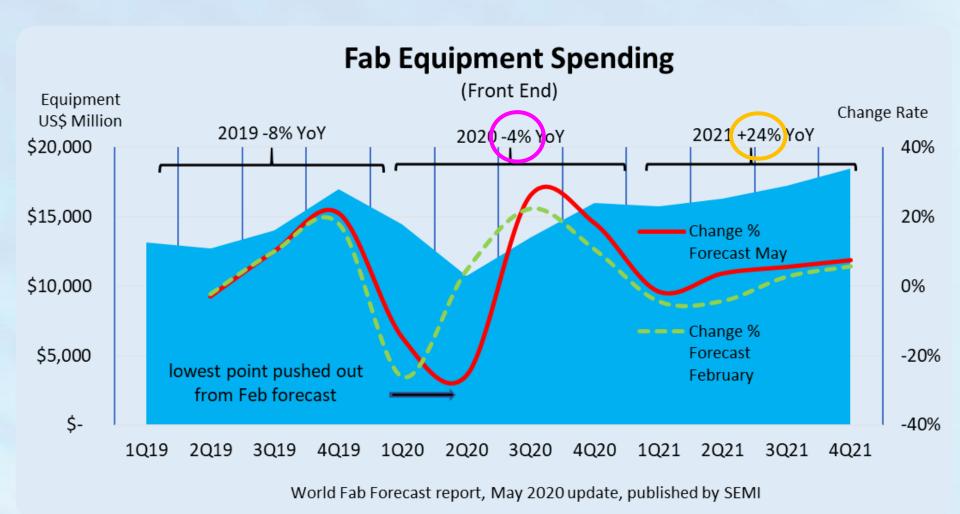


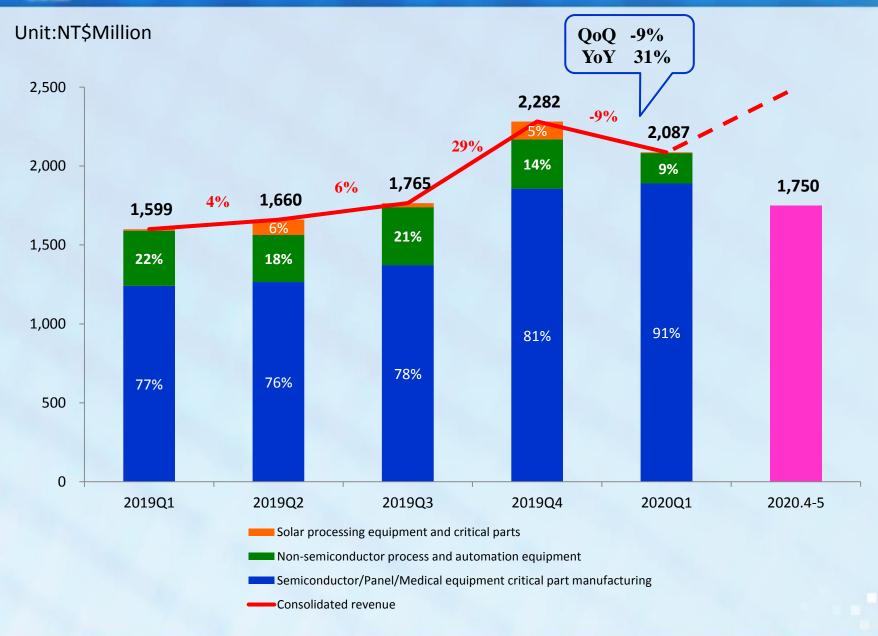












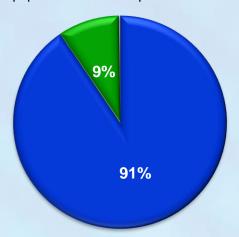


Revenue Breakdowns by Products (Year-over-Year)

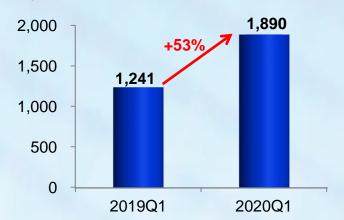
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2020Q1

- Semiconductor/Panel/Medical equipment critical part manufacturing
- Non-semiconductor process and automation equipment
- Solar processing equipment and critical parts



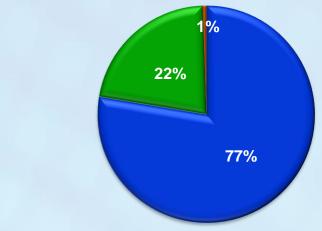
Unit:NT\$Million



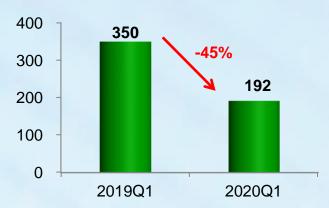
 Semiconductor/Panel/Medical equipment critical part manufacturing

2019Q1

- Semiconductor/Panel/Medical equipment critical part manufacturing
- Non-semiconductor process and automation equipment
- Solar processing equipment and critical parts



Unit:NT\$Million



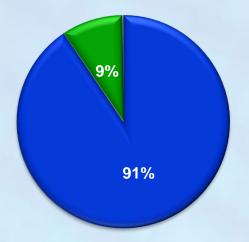
Non-semiconductor process and automation equipment



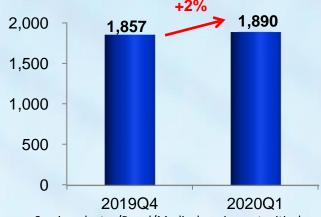
Revenue Breakdowns by Products (Quarter-over-Quarter) 3413.TT

2020Q1

- Semiconductor/Panel/Medical equipment critical part manufacturing
- Non-semiconductor process and automation equipment
- Solar processing equipment and critical parts



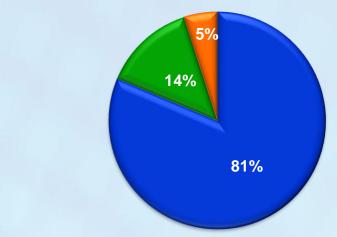
Unit:NT\$Million



 Semiconductor/Panel/Medical equipment critical part manufacturing

2019Q4

- Semiconductor/Panel/Medical equipment critical part manufacturing
- Non-semiconductor process and automation equipment
- Solar processing equipment and critical parts



Unit:NT\$Million



Non-semiconductor process and automation equipment



2020Q1 Consolidated Statement of Income



Unit: NT\$ K	2020Q1	2019Q1	YoY	
Operating revenue	2,086,841	1,599,559	30%	
Gross Profit margin	23%	20%	3 ppts	
Operating expense	(213,377)	(225,840)	-6%	
Net operating profit	274,607	93,541	194%	
Net operating profit %	13%	6%	7 ppts	
Non-Operating Items	12,730	8,514	50%	
Net profit before tax	287,337	102,055	182%	
Net profit before tax %	14%	6%	8ppts	
Net Income to Shareholders of the Parent Company	236,388	86,220	174%	
Net Profit Margin	12%	5%	7 ppts	
EPS (NTD)	2.86	1.04	175%	
Weighted-average outstanding shares(k)	82,691	82,688		

Unit: NT\$

Year	2015	2016	2017	2018	2019
EPS (Before stock dividends)	8.11	9.05	13.63	14.06	7.85
Cash DPS(NT\$)	4	4	6	7	4
Stock DPS(NT\$)	-	0.5	0.5	-	-
Total	4	4.5	6.5	7	4
Payout ratio(%)	49%	50%	48%	50%	51%



Recap of Recent Major Events

- Fiti 5/28 shareholders meeting approved a cash dividend of NT\$4, and the chairman and former board members were reelected.
- Outlook: optimistic in the second quarter, slightly slower in the third quarter, optimistic for the full year.
- FITI Chunan No. 2 Factory Plant is expected to start construction in the third quarter.



Thanks for your attention.

京鼎精密科技股份有限公司 Foxsemicon Integrated Technology, Inc.